Product data sheet

1. General description

High power density, hyperfast recovery rectifier with high-efficiency planar technology, encapsulated in a CFP2-HP (SOD323HP) power and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Reverse voltage: V_R ≤ 200 V
- Forward current: I_F ≤ 1 A
- Hyperfast recovery time: t_{rr} ≤ 25 ns
- · Planar die design with Pt doped life time control
- Low inductance
- Small and flat lead SMD plastic package, typical height 0.68 mm
- · High power capability due to clip-bond technology
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- General-purpose rectification
- · Reverse polarity protection
- · Hyperfast switching
- Freewheeling applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 170 °C	-	-	1	Α
V _R	reverse voltage	T _j = 25 °C	-	-	200	V
V _F	forward voltage	I _F = 1 A; pulsed; T _j = 25 °C	-	880	1020	mV
I _R	reverse current	$V_R = 200 \text{ V}$; pulsed; $T_j = 25 \text{ °C}$	-	-	75	nA
		V _R = 200 V; pulsed; T _j = 125 °C	-	0.6	5	μΑ



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	, Th	
2	Α	anode	1] [2	K-A
			Transparent top view CFP2-HP (SOD323HP)	006aab040

6. Ordering information

Table 3. Ordering information

ype number Package								
	Name	Description	Version					
PNE20010EXD-Q	CFP2-HP	SOD323HP: plastic surface-mounted package with solderable lead ends; 2.2 mm x 1.3 mm x 0.68 mm body	SOD323HP					

7. Marking

Table 4. Marking codes

Type number	Marking code
PNE20010EXD-Q	2K

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	200	V
l _F	forward current	δ = 1; T _{sp} ≤ 169 °C		-	1.4	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 170 °C		-	1	A
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; single half sine wave (applied at reated load condition); $T_{j(init)}$ = 25 °C		-	25	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	0.65	W
			[2]	-	1.2	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

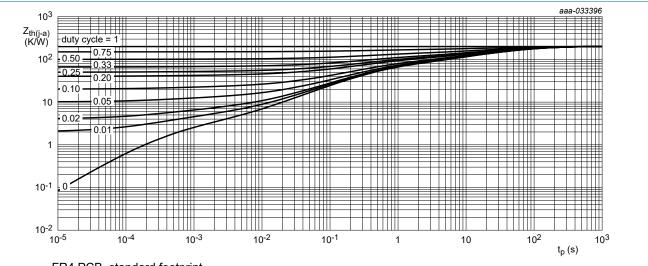
- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

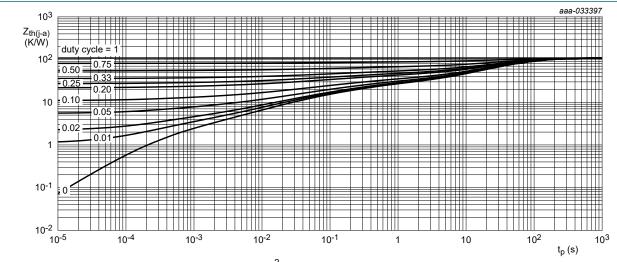
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1] [2]	-	-	230	K/W
junction to ambient		[1] [3]	-	-	125	K/W	
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	6	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses PR are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

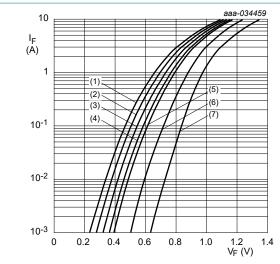
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 0.1 \text{ mA}$; pulsed; $T_j = 25 \text{ °C}$		200	-	-	V
V _F	forward voltage	I _F = 0.1 A; pulsed; T _j = 25 °C	[1]	-	720	840	mV
		I _F = 0.5 A; pulsed; T _j = 25 °C	[1]	-	825	935	mV
		I _F = 1 A; pulsed; T _j = 25 °C		-	880	1020	mV
		I _F = 1 A; pulsed; T _j = -40 °C		-	975	1100	mV
		I _F = 1 A; pulsed; T _j = 125 °C		-	730	870	mV
I _R	reverse current	V _R = 200 V; pulsed; T _j = 25 °C		-	-	75	nA
		V _R = 200 V; pulsed; T _j = 125 °C		-	0.6	5	μA
		V _R = 200 V; pulsed; T _j = 150 °C		-	2.5	15	μA
C _d	diode capacitance	V _R = 4 V; f = 1 MHz; T _j = 25 °C		-	10	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C		-	8	-	pF
t _{rr}	reverse recovery time; step recovery	$I_F = 0.5 \text{ A}$; $I_R = 1 \text{ A}$; $I_{R(meas)} = 0.25 \text{ A}$; $I_{j} = 25 \text{ °C}$		-	9	25	ns
	reverse recovery time; ramp recovery	$I_F = 1 \text{ A}; dI_F/dt = 50 \text{ A/}\mu\text{s}; V_R = 30 \text{ V};$ $T_j = 25 \text{ °C}$		-	15	-	ns
I _{RM}	peak reverse recovery current			-	0.45	-	Α
Q _{rr}	reverse recovery charge			-	4	-	nC
V_{FRM}	peak forward recovery voltage	$I_F = 1 \text{ A}; dI_F/dt = 50 \text{ A/}\mu\text{s}; T_j = 25 °C$		-	1	-	V

^[1] Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

(1) Tj = 175 °C

(2) Tj = 150 °C

(3) Tj = 125 °C

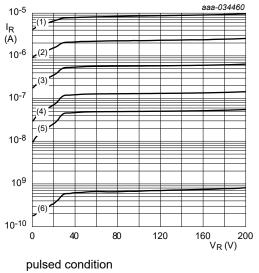
(4) Tj = 100 °C

(5) Tj = 85 °C

(6) Tj = 25 °C

(7) Tj = -40 °C

Forward current as a function of forward Fig. 3. voltage; typical values



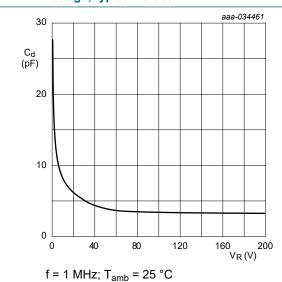
(1) $T_j = 175 \, ^{\circ}C$

(2) $T_j = 150 \, ^{\circ}\text{C}$

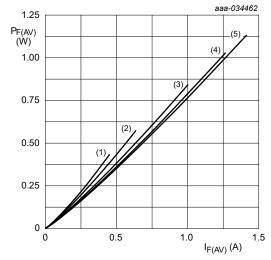
(3) $T_j^J = 125 °C$ (4) $T_j = 100 °C$ (5) $T_i = 85 °C$

(6) $T_j' = 25 \, ^{\circ}C$

Fig. 4. Reverse current as a function of reverse voltage; typical values



Diode capacitance as a function of reverse Fig. 5. voltage; typical values



T_i = 100 °C

 $(1) \delta = 0.1$

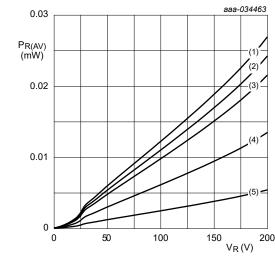
 $(2) \delta = 0.2$

 $(3) \delta = 0.5$

 $(4) \delta = 0.8$

(5) δ = 1; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 100 \, ^{\circ}C$

 $(1) \delta = 1$; DC

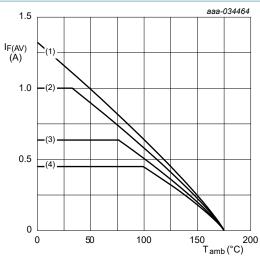
 $(2) \delta = 0.9$

 $(3) \delta = 0.8$

 $(4) \delta = 0.5$

 $(5) \delta = 0.2$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

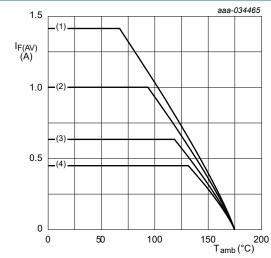
 $(1) \delta = 1; DC$

 $(2) \delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm² $T_i = 175$ °C

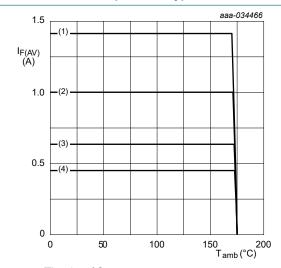
 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

 $(3) \delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Tj = 175 °C

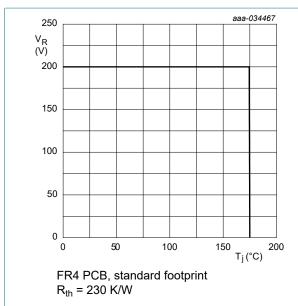
(1) δ = 1; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

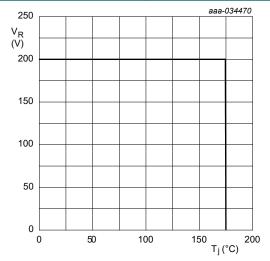
Fig. 10. Average forward current as a function of solder point temperature; typical values



aaa-034469 250 V_R (V) 200 150 100 50 0 50 100 FR4 PCB, mounting pad for cathode 1 cm² R_{th} = 125 K/W

of junction temperature; typical values

Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



Soldering point of cathode tab $R_{th} = 6 \text{ K/W}$

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

11. Test information

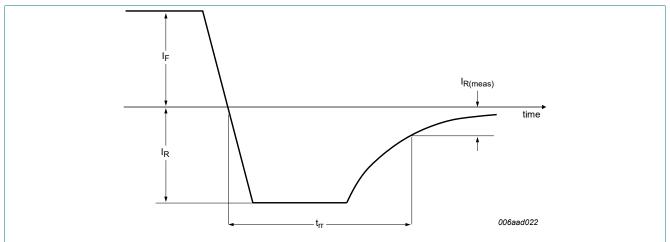


Fig. 14. Reverse recovery definition; step recovery

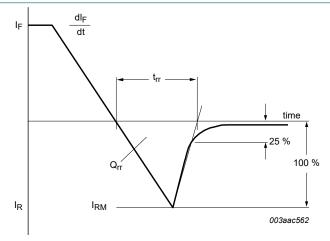


Fig. 15. Reverse recovery definition; ramp recovery

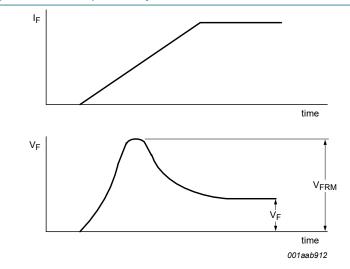
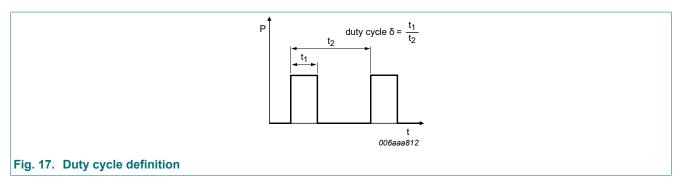


Fig. 16. Forward recovery definition



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)}=I_M\times\delta$ with I_M defined as peak current

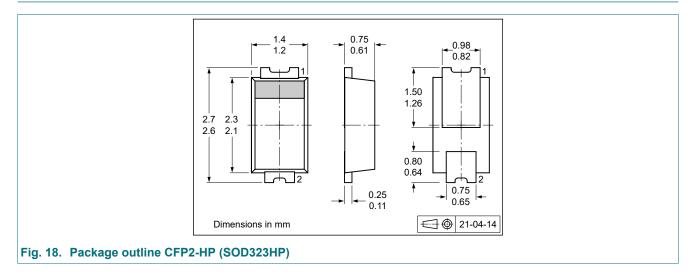
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$

with I_{RMS} defined as RMS current.

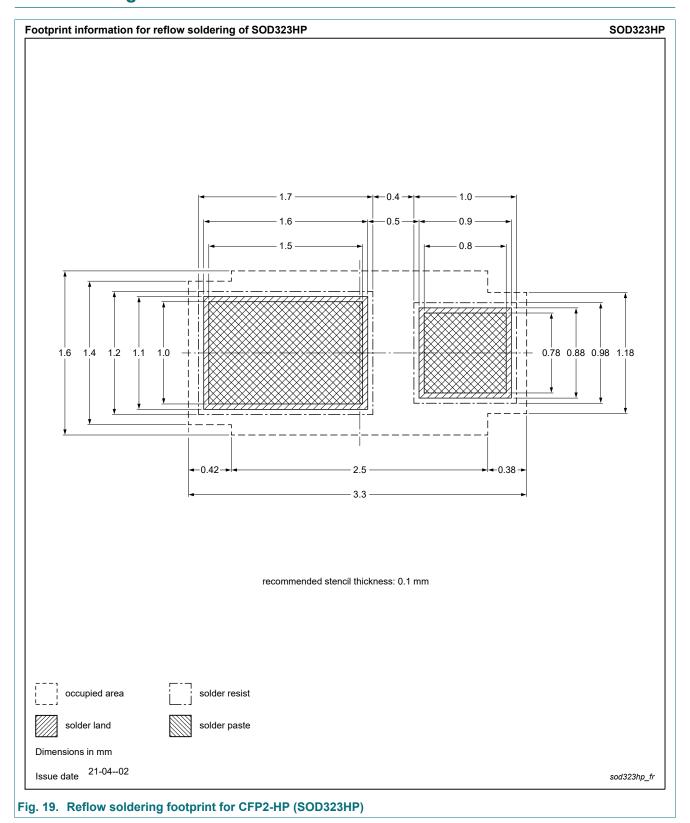
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date		Change notice	Supersedes
PNE20010EXD-Q v.1	20220401	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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PNE20010EXD-Q

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